

PMEG3005AESF

30 V, 0.5 A low VF MEGA Schottky barrier rectifier

10 March 2017 **Product data sheet**

1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection in a DSN0603-2 (SOD962-2) leadless ultra small Chip-Scale Package (CSP).

2. Features and benefits

- Average forward current $I_{F(AV)} \leq 0.5$ A
- Reverse voltage $V_R \leq 30$ V
- Low forward voltage typ. $V_F = 250$ mV
- Low reverse current typ. $I_R = 4$ µA
- Package height typ. 0.3 mm

3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Ultra high speed switching
- LED backlight for mobile application

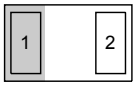
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
I_F	forward current	$T_{sp} \leq$ 135 °C; δ = 1		-	-	0.7	A
V_R	reverse voltage	T_j = 25 °C		-	-	30	V
V_F	forward voltage	I_F = 200 mA; $t_p \leq$ 300 µs; δ ≤ 0.02 ; T_j = 25 °C		-	405	470	mV
I_R	reverse current	V_R = 30 V; T_j = 25 °C; pulsed		-	20	80	µA

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]	 Transparent top view **DSN0603-2 (SOD962-2)**	 *sym001*
2	A	anode		

[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG3005AESF	DSN0603-2	Leadless ultra small package; 2 terminals; body 0.6 x 0.3 x 0.3 mm	SOD962-2

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG3005AESF	8

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	T_j = 25 °C		-	30	V
I_F	forward current	$T_{sp} \leq$ 135 °C; δ = 1		-	0.7	A
$I_{F(AV)}$	average forward current	δ = 0.5 ; f = 20 kHz; $T_{amb} \leq$ 105 °C; square wave	[1]	-	0.5	A
		δ = 0.5 ; f = 20 kHz; $T_{sp} \leq$ 140 °C; square wave		-	0.5	A
I_{FRM}	repetitive peak forward current	$t_p \leq$ 1 ms; δ ≤ 0.25		-	1.5	A
I_{FSM}	non-repetitive peak forward current	t_p = 8 ms; $T_{j(init)}$ = 25 °C; square wave		-	4	A
P_{tot}	total power dissipation	$T_{amb} \leq$ 25 °C	[2]	-	405	mW
			[3]	-	660	mW

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Symbol	Parameter	Conditions		Min	Max	Unit
			[1]	-	1200	mW
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

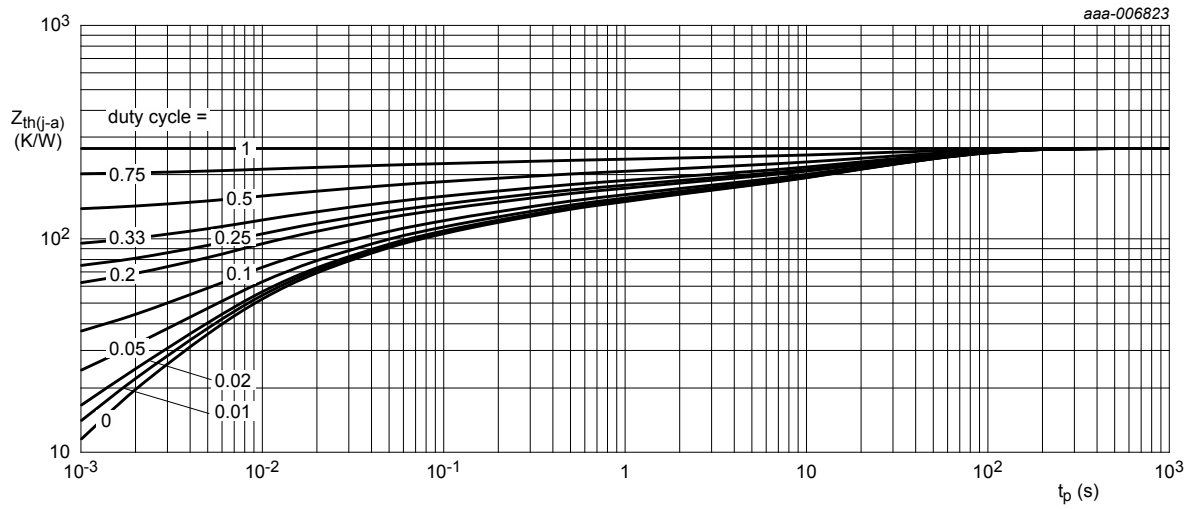
[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al_2O_3, standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for anode and cathode 1 cm^2 each.

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	310	K/W
			[1] [3]	-	-	190	K/W
			[1] [4]	-	-	105	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[5]	-	-	40	K/W

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for anode and cathode 1 cm^2 each.
[4] Device mounted on a ceramic PCB, Al_2O_3, standard footprint.
[5] Soldering point of anode tab.

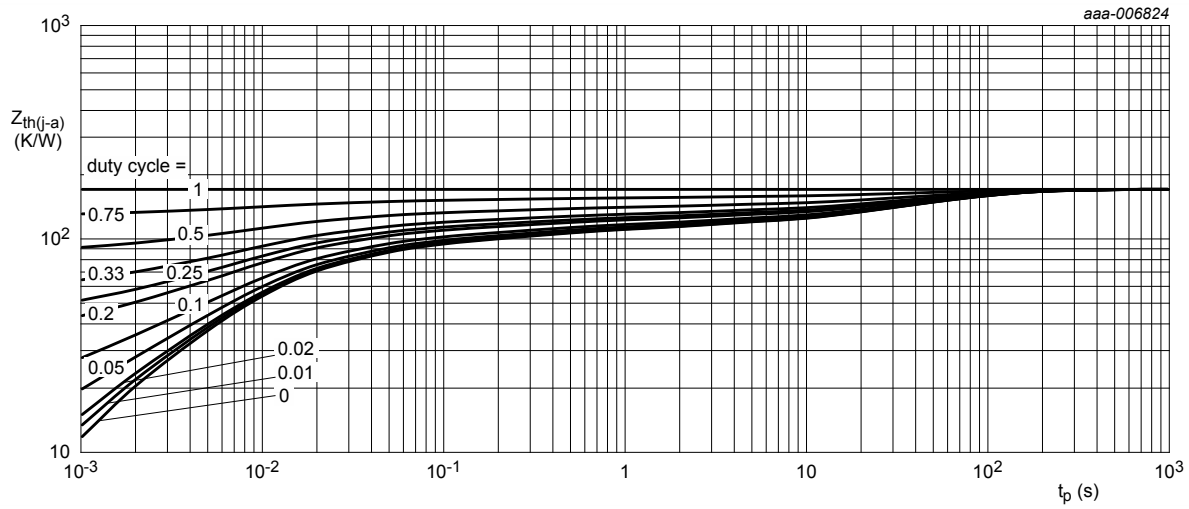


FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

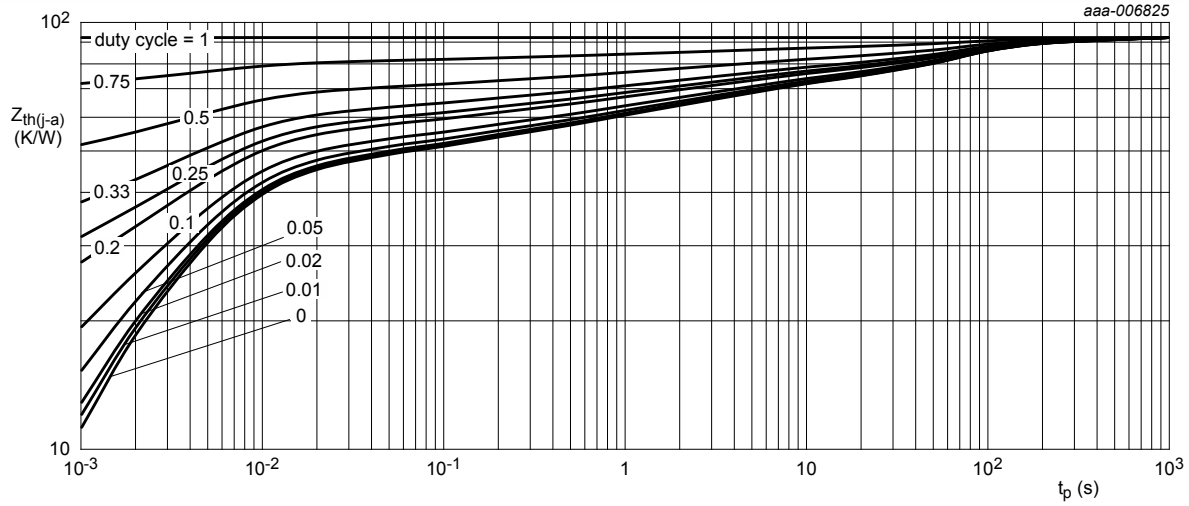
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FR4 PCB, mounting pad for anode and cathode 1 cm^2 each

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



Ceramic PCB, Al_2O_3, standard footprint

Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

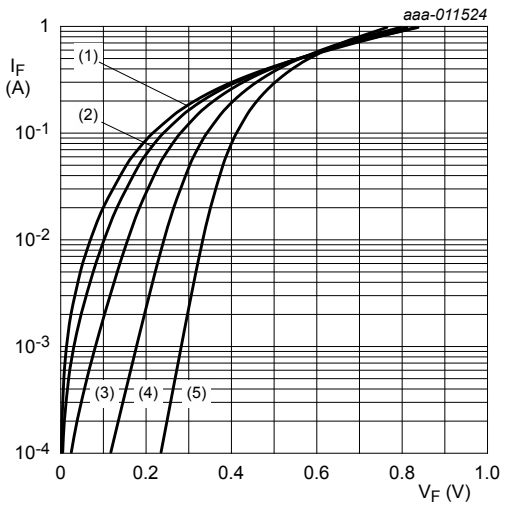
Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{(BR)R}$	reverse reverse breakdown voltage	I_R = 100 µA; t_p = 300 µs; δ = 0.02 ; T_j = 25 °C		30	-	-	V
V_F	forward voltage	I_F = 0.1 mA; $t_p \leq$ 300 µs; δ ≤ 0.02 ; T_j = 25 °C		-	120	185	mV
		I_F = 1 mA; $t_p \leq$ 300 µs; δ ≤ 0.02 ; T_j = 25 °C		-	180	245	mV
		I_F = 10 mA; $t_p \leq$ 300 µs; δ ≤ 0.02 ; T_j = 25 °C		-	250	320	mV

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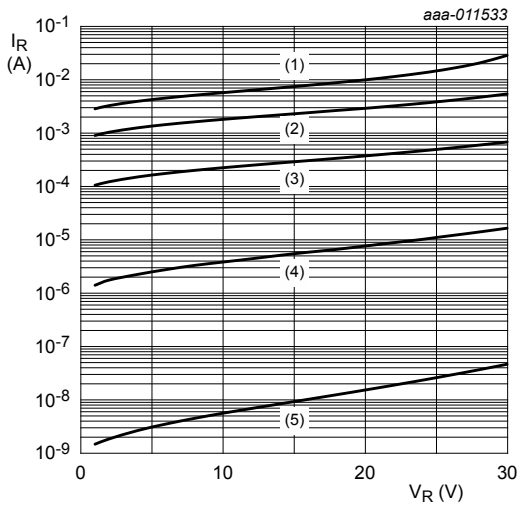
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Symbol	Parameter	Conditions		Min	Typ	Max	Unit
		I_F = 100 mA; $t_p \leq$ 300 µs; $\delta \leq$ 0.02 ; T_j = 25 °C		-	350	410	mV
		I_F = 200 mA; $t_p \leq$ 300 µs; $\delta \leq$ 0.02 ; T_j = 25 °C		-	405	470	mV
		I_F = 500 mA; $t_p \leq$ 300 µs; $\delta \leq$ 0.02 ; T_j = 25 °C		-	560	630	mV
I_R	reverse current	V_R = 10 V; T_j = 25 °C; pulsed		-	4	30	µA
		V_R = 30 V; T_j = 25 °C; pulsed		-	20	80	µA
C_d	diode capacitance	V_R = 1 V; f = 1 MHz; T_j = 25 °C		-	22	-	pF
		V_R = 10 V; f = 1 MHz; T_j = 25 °C		-	8	-	pF
t_{rr}	reverse recovery time	I_F = 500 mA; I_R = 500 mA; $I_{R(meas)}$ = 100 mA; T_j = 25 °C		-	1.37	-	ns



pulsed condition
(1) T_j = 150 °C
(2) T_j = 125 °C
(3) T_j = 85 °C
(4) T_j = 25 °C
(5) T_j = −40 °C

Fig. 4. Forward current as a function of forward voltage; typical values

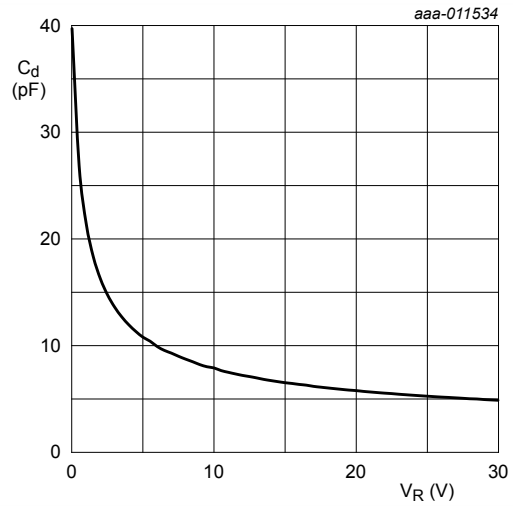


pulsed condition
(1) T_j = 150 °C
(2) T_j = 125 °C
(3) T_j = 85 °C
(4) T_j = 25 °C
(5) T_j = −40 °C

Fig. 5. Reverse current as a function of reverse voltage; typical values

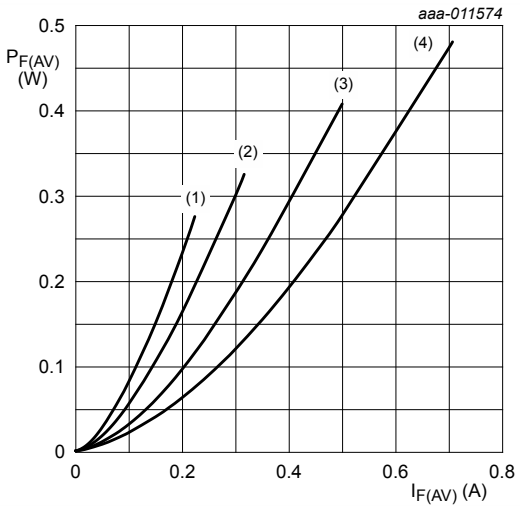
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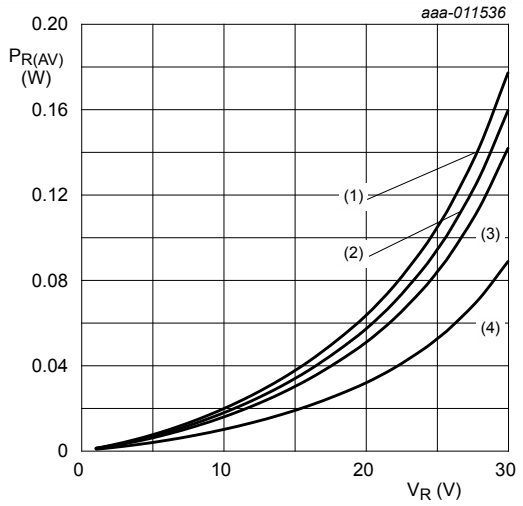
f = 1 MHz; T_{amb} = 25 °C

Fig. 6. Diode capacitance as a function of reverse voltage; typical values



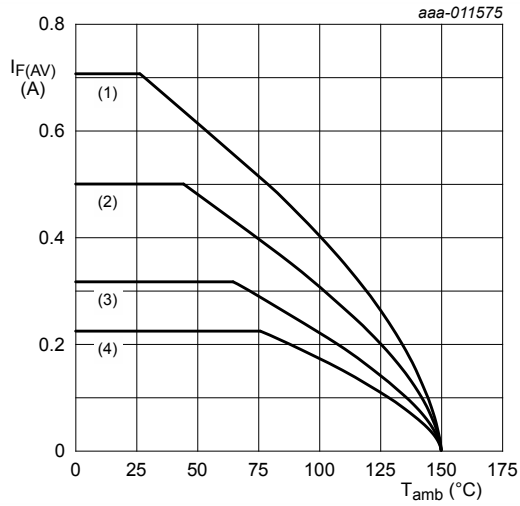
T_j = 150 °C
(1) δ = 0.1
(2) δ = 0.2
(3) δ = 0.5
(4) δ = 1

Fig. 7. Average forward power dissipation as a function of average forward current; typical values



T_j = 125 °C
(1) δ = 1
(2) δ = 0.9
(3) δ = 0.8
(4) δ = 0.5

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values

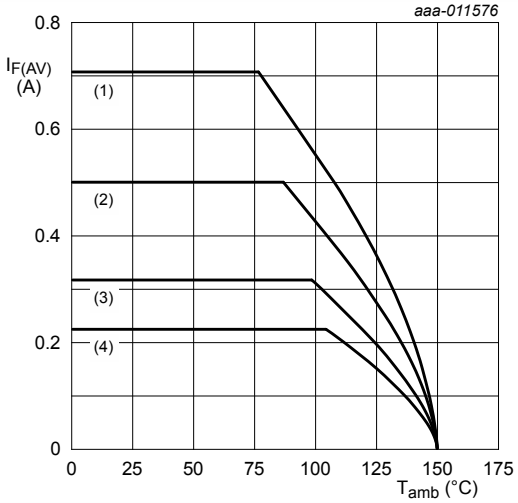


FR4 PCB, standard footprint
T_j = 150 °C
(1) δ = 1; DC
(2) δ = 0.5; f = 20 kHz
(3) δ = 0.2; f = 20 kHz
(4) δ = 0.1; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values

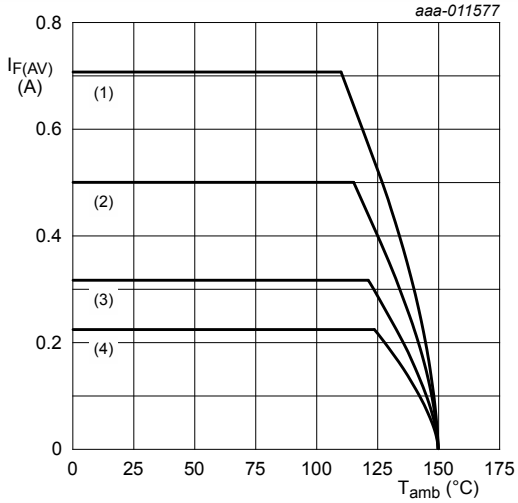
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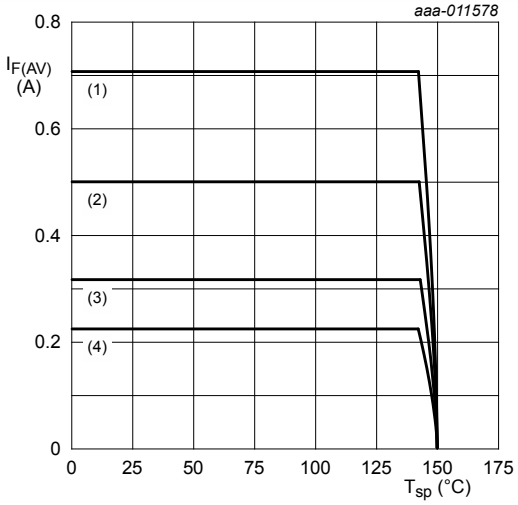
FR4 PCB, mounting pad for anode and cathode 1 cm^2 each
T_j = 150 °C
(1) δ = 1; DC
(2) δ = 0.5; f = 20 kHz
(3) δ = 0.2; f = 20 kHz
(4) δ = 0.1; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al_2O_3, standard footprint
T_j = 150 °C
(1) δ = 1; DC
(2) δ = 0.5; f = 20 kHz
(3) δ = 0.2; f = 20 kHz
(4) δ = 0.1; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



T_j = 150 °C
(1) δ = 1; DC
(2) δ = 0.5; f = 20 kHz
(3) δ = 0.2; f = 20 kHz
(4) δ = 0.1; f = 20 kHz

Fig. 12. Average forward current as a function of solder point temperature; typical values

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11. Test information

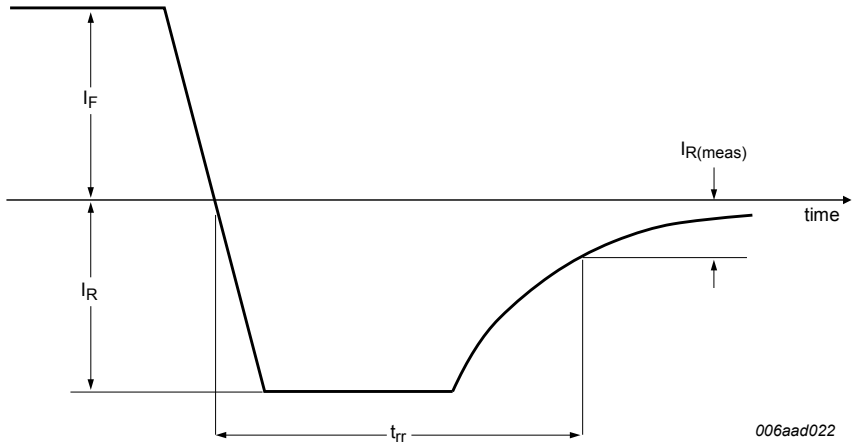


Fig. 13. Reverse recovery definition

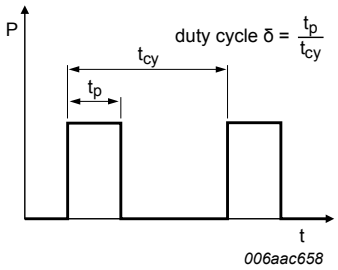


Fig. 14. Duty cycle definition

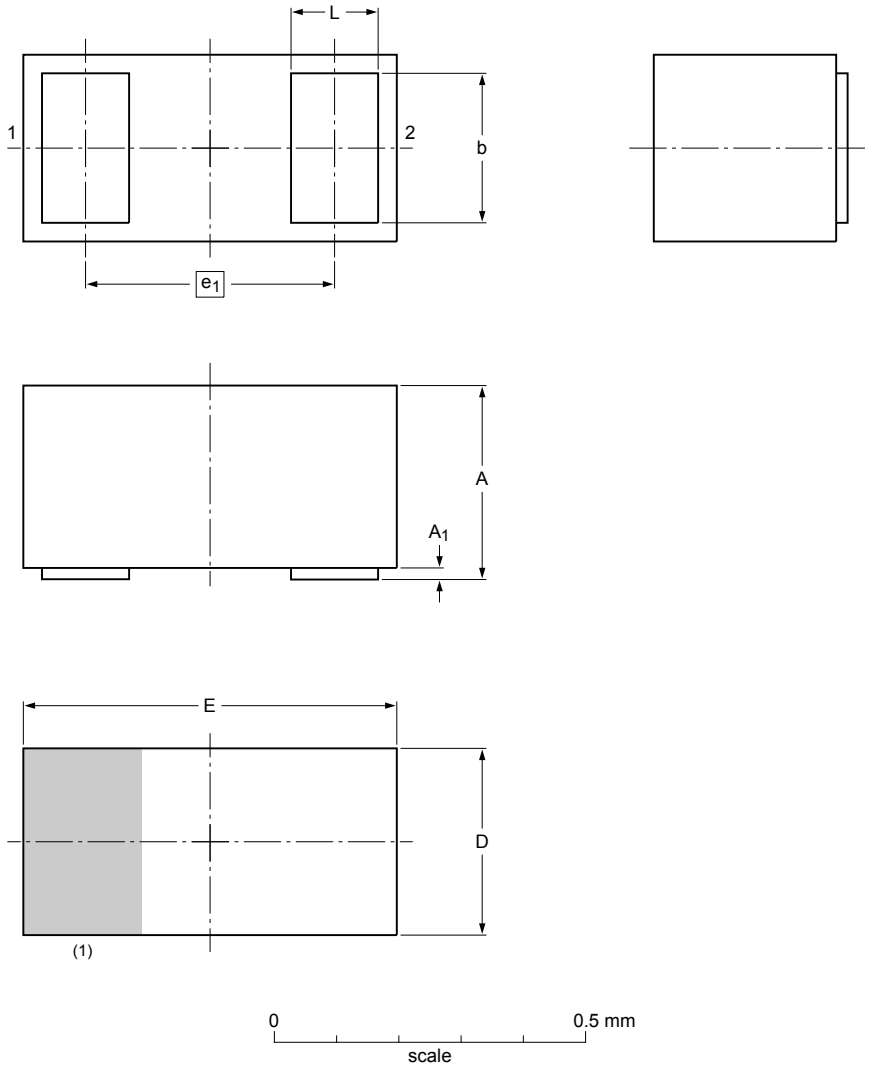
The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

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12. Package outline

Leadless ultra small package; 2 terminals; body 0.6 x 0.3 x 0.3 mm **SOD962-2**



Dimensions (mm are the original dimensions)

Unit		A	A_1	b	D	E	e_1	L
mm	max	0.32	0.03	0.25	0.325	0.625		0.15
	nom						0.4	
	min	0.28		0.23	0.275	0.575		0.13

Note
1. The marking bar indicates the cathode.

sod962-2_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOD962-2						~~13-07-12~~ 13-07-17

Fig. 15. Package outline DSN0603-2 (SOD962-2)

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13. Soldering

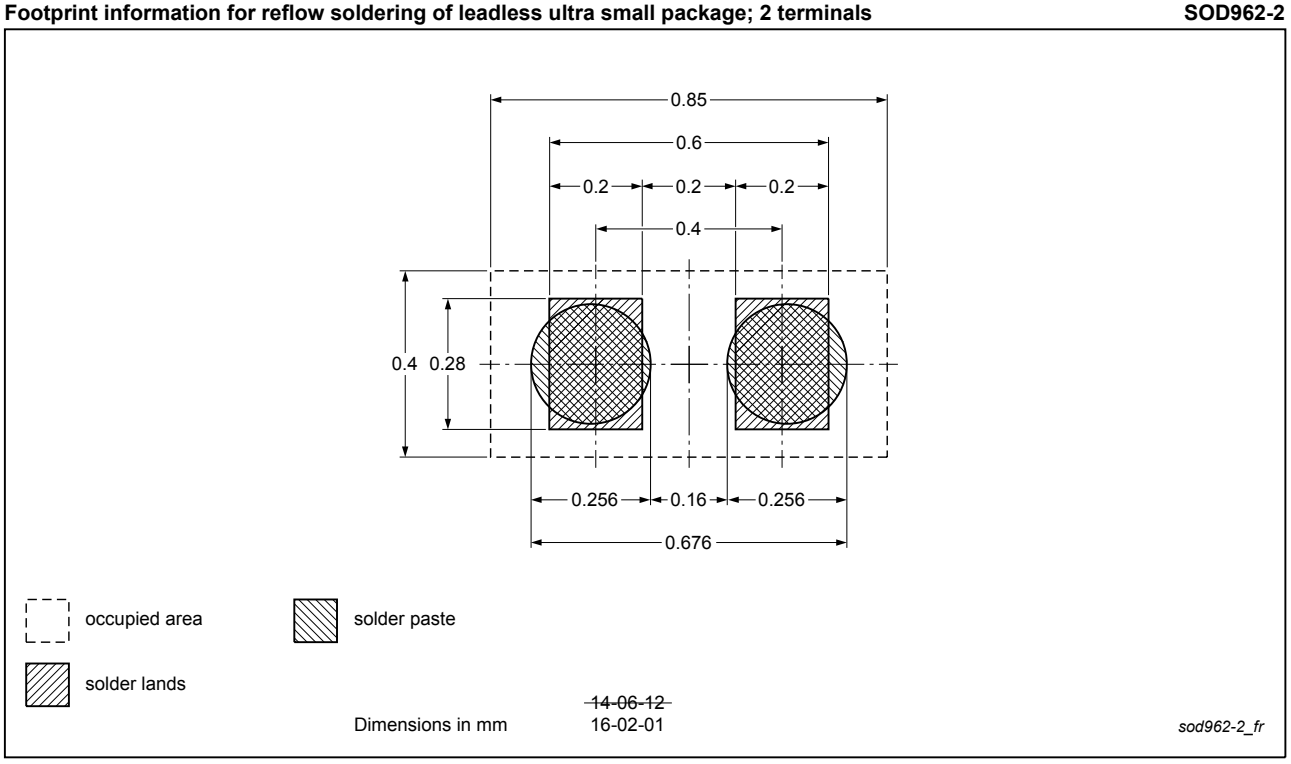


Fig. 16. Reflow soldering footprint for DSN0603-2 (SOD962-2)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG3005AESF v.1	20170310	Product data sheet	-	-

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15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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16. Contents

1. General description....1
2. Features and benefits....1
3. Applications....1
4. Quick reference data....1
5. Pinning information....2
6. Ordering information....2
7. Marking....2
8. Limiting values....2
9. Thermal characteristics....3
10. Characteristics....4
11. Test information....8
12. Package outline....9
13. Soldering....10
14. Revision history....10
15. Legal information....11

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